

# MB005S THRU MB10S

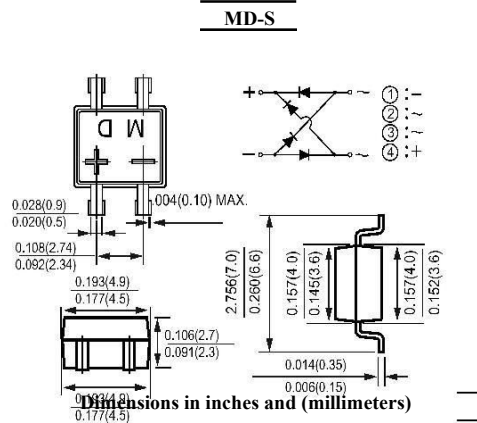
**REVERSE VOLTAGE:** 50 to 1000 VOLTS  
**FORWARD CURRENT:** 0.5 AMPERE

## FEATURES

- Glass passivated chip junction
- Low forward voltage drop
- High surge overload rating of 30 Amperes peak
- Ideal for printed circuit board
- High temperature soldering guaranteed:  
260°C for 10 seconds

## MECHANICAL DATA

Case: Molded plastic, MD-S  
 Epoxy: UL 94V-O rate flame retardant  
 Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed  
 Mounting position: Any Weight:  
 0.008ounce, 0.22gram



## Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.  
 Single phase, half wave, 60HZ, resistive or inductive load.  
 For capacitive load, derate current by 20%.

	Symbols	MB005S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Maximum Recurrent Peak Reverse Voltage	$V_{RRM}$	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current (see Fig. 1) on glass-epoxy P.C.B (Note 2) on aluminum substrate (Note 3)	$I_{(AV)}$	0.5 0.8							Amp
Peak Forward Surge Current, 8.3ms single half-sine-wave superimposed on rated load (JEDEC method)	$I_{FSM}$	30							Amp
Maximum Forward Voltage at 0.4A DC and 25°C	$V_F$	1.0							Volts
Maximum Reverse Current at $T_A=25^\circ\text{C}$ at Rated DC Blocking Voltage $T_A=125^\circ\text{C}$	$I_R$	5.0 500							$\mu\text{Amp}$
Typical Junction Capacitance (Note 1)	$C_J$	13							pF
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	70							$^\circ\text{C}/\text{W}$
Typical Thermal Resistance (Note 2)	$R_{\theta JL}$	20							$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150							$^\circ\text{C}$

## NOTES:

- 1- Measured at 1 MHz and applied reverse voltage of 4.0 VDC.
- 2- On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads
- 3- On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad

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Characteristic Curves ( $T_A=25\text{ }^\circ\text{C}$  unless otherwise noted)

